

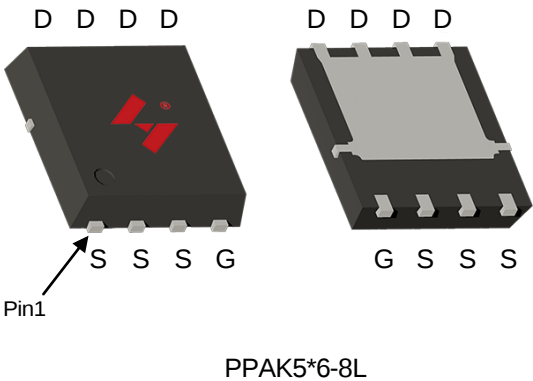
HY030N06C2

Single N-Channel Enhancement Mode MOSFET

Feature

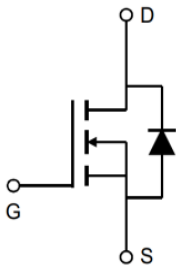
- 65V/100A
 $R_{DS(ON)} = 2.4\text{ m}\Omega(\text{typ.})@V_{GS} = 10\text{V}$
 $R_{DS(ON)} = 3.7\text{ m}\Omega(\text{typ.})@V_{GS} = 4.5\text{V}$
- 100% Avalanche Tested
- Reliable and Rugged
- Halogen- Free Devices Available

Pin Description



Applications

- Hard switched and high frequency circuits
- Power switching application
- Uninterruptible power supply



Single N-Channel MOSFET

Ordering and Marking Information

 C2 HY030N06 YYXXXLWW G	<table><tr><td data-bbox="821 1440 1026 1518">Package Code C2: PPAK5*6-8L</td><td data-bbox="1109 1565 1334 1644">Assembly Material G: Halogen- Free</td></tr><tr><td data-bbox="821 1565 1010 1644">Date Code YYXXXLWW G</td><td></td></tr></table>	Package Code C2: PPAK5*6-8L	Assembly Material G: Halogen- Free	Date Code YYXXXLWW G	
Package Code C2: PPAK5*6-8L	Assembly Material G: Halogen- Free				
Date Code YYXXXLWW G					

Note: HUAYI lead-free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish; which are fully compliant with RoHS. HUAYI lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines “Green” to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this product and/or to this document at any time without notice.

Absolute Maximum Ratings

Symbol	Parameter		Rating	Unit
Common Ratings (Tc=25°C Unless Otherwise Noted)				
V _{DSS}	Drain-Source Voltage		65	V
V _{GSS}	Gate-Source Voltage		+20/-12	V
T _J	Junction Temperature Range		-55 to 150	°C
T _{STG}	Storage Temperature Range		-55 to 150	°C
I _S	Source Current-Continuous(Body Diode)	Tc=25°C	100	A
Mounted on Large Heat Sink				
I _{DM}	Pulsed Drain Current *	Tc=25°C	360	A
I _D	Continuous Drain Current	Tc=25°C	100	A
		Tc=100°C	63.2	A
P _D	Maximum Power Dissipation	Tc=25°C	48	W
		Tc=100°C	19.2	W
R _{θJC}	Thermal Resistance, Junction-to-Case		2.6	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient **		35	°C/W
E _{AS}	SinglePulsed-Avalanche Energy ***	L=0.1mH	289.8	mJ

Note: * Repetitive rating; pulse width limited by max.junction temperature.

** Surface mounted on FR-4 board.

*** Limited by T_{Jmax}, starting T_J=25°C, L = 0.1mH, R_G =25Ω, V_{GS} =10V.

Electrical Characteristics(Tc =25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	HY030N06			Unit
			Min	Typ.	Max	
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	65	-	-	V
I _{DSS}	Drain-to-Source Leakage Current	V _{DS} =65V, V _{GS} =0V	-	-	1	μA
		T _J =125°C	-	-	50	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	1	1.6	2.5	V
I _{GSS}	Gate-Source Leakage Current	V _{GS} =+20/-12V, V _{DS} =0V	-	-	±100	nA
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _{DS} =20A	-	2.4	2.8	mΩ
		V _{GS} =4.5V, I _{DS} =20A	-	3.7	4.5	mΩ
Diode Characteristics						
V _{SD} *	Diode Forward Voltage	I _{SD} =20A, V _{GS} =0V	-	0.78	1.1	V
t _{rr}	Reverse Recovery Time	I _{SD} =20A, dI _{SD} /dt=100A/μs	-	43	-	ns
Q _{rr}	Reverse Recovery Charge		-	50	-	nC

Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

Note: *Pulse test, pulse width ≤ 300us, duty cycle ≤ 2%

Typical Operating Characteristics

Figure 1: Power Dissipation

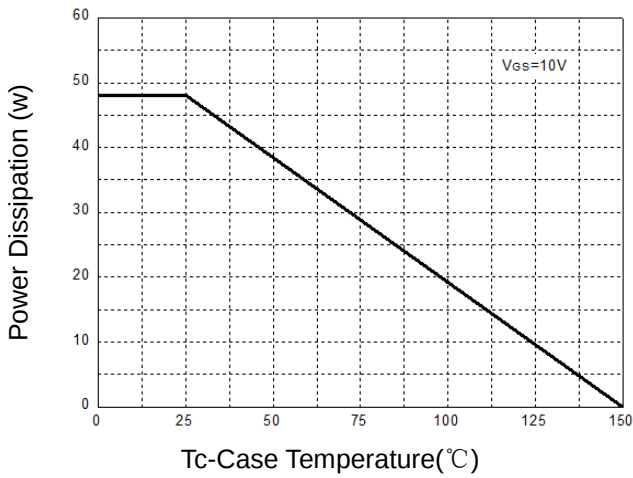


Figure 2: Drain Current

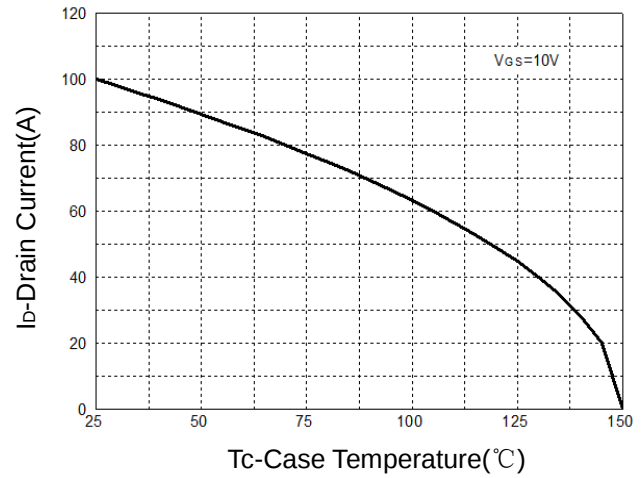


Figure 3: Safe Operation Area

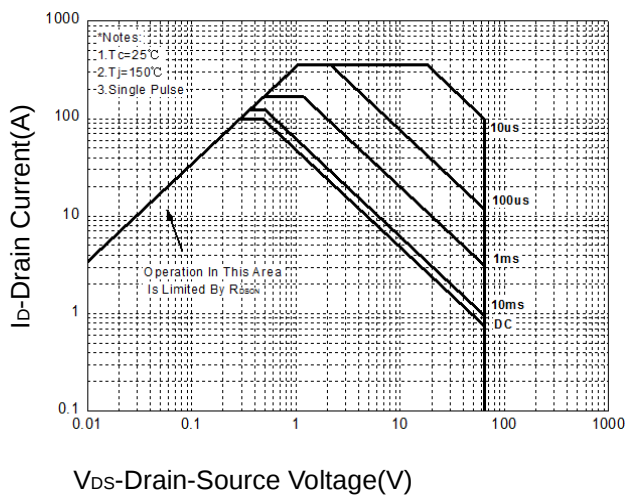


Figure 4: Thermal Transient Impedance

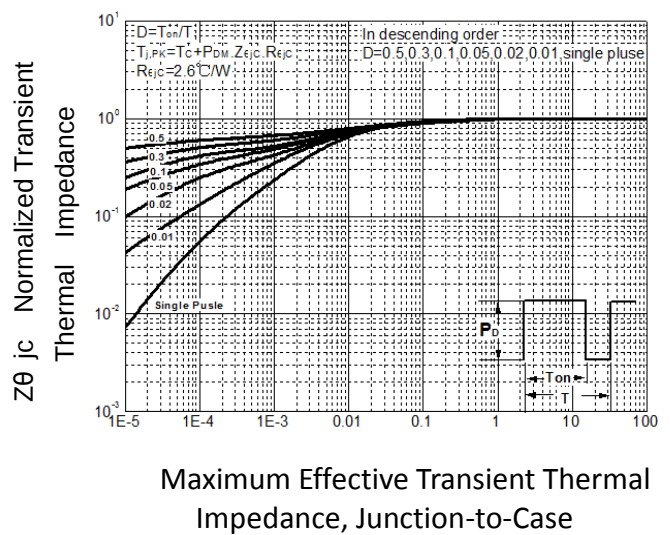


Figure 5: Output Characteristics

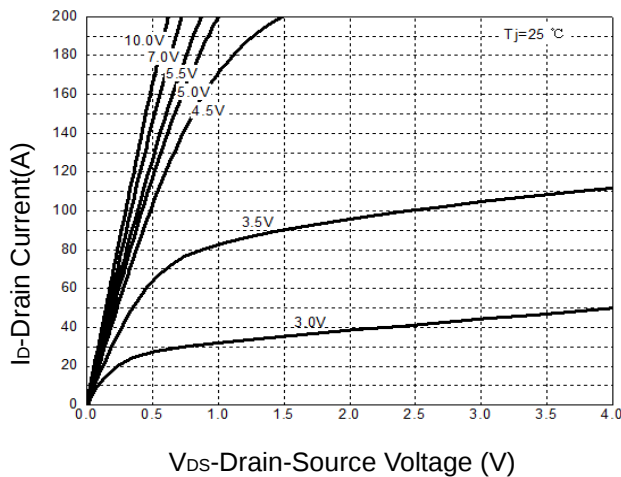
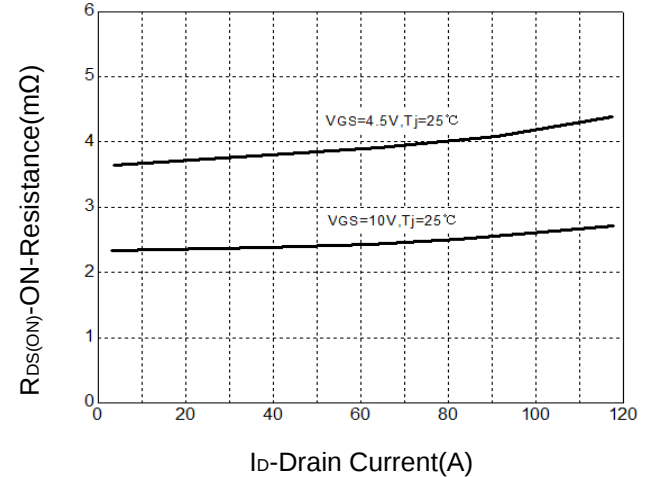


Figure 6: Drain-Source On Resistance



Typical Operating Characteristics(Cont.)

Figure 7: On-Resistance vs. Temperature

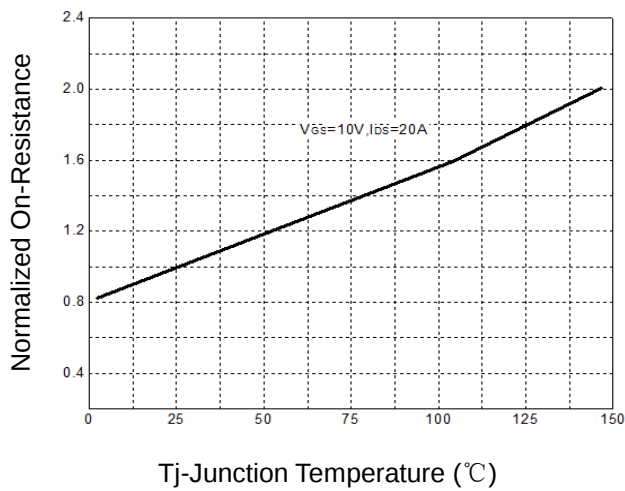


Figure 8: Source-Drain Diode Forward

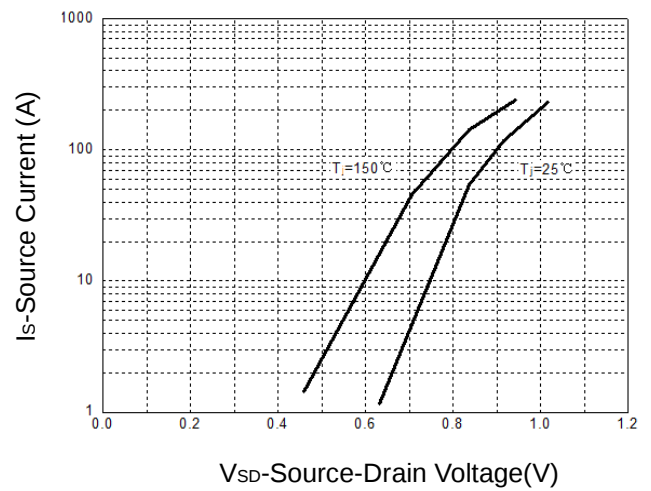


Figure 9: Capacitance Characteristics

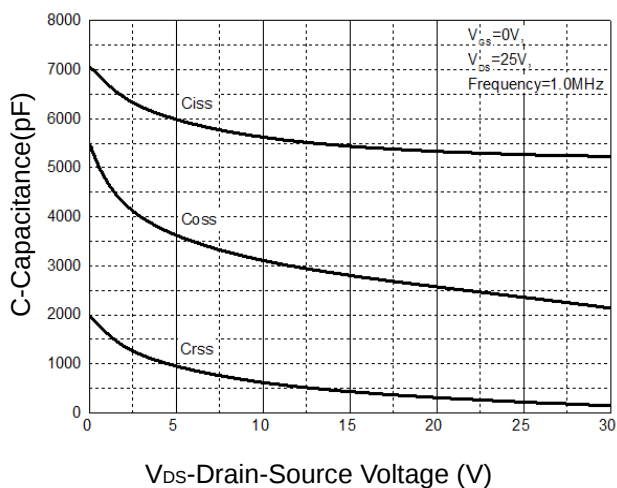
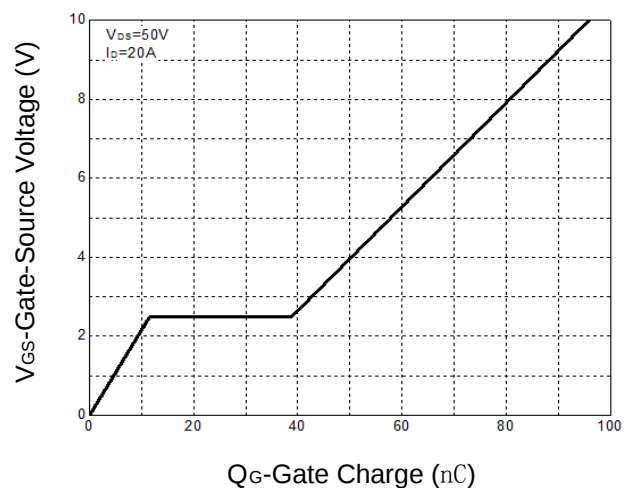
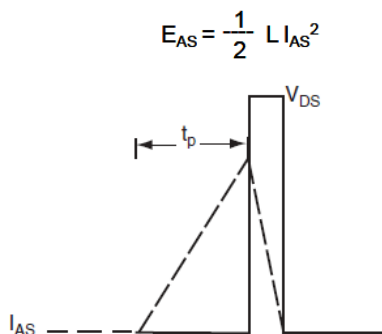
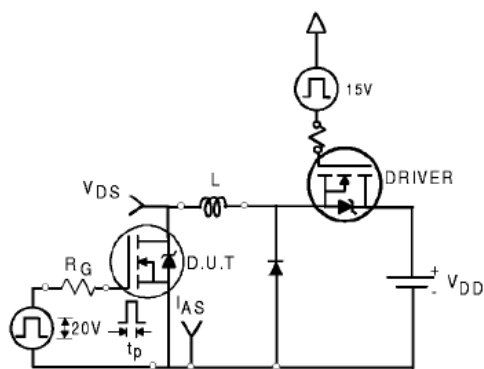


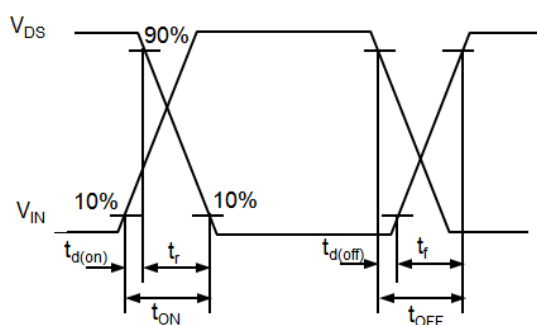
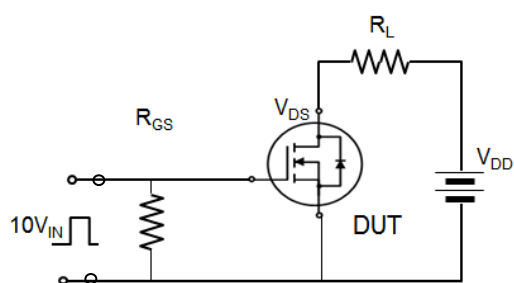
Figure 10: Gate Charge Characteristics



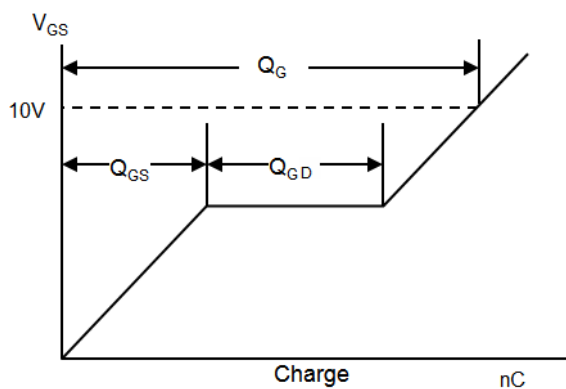
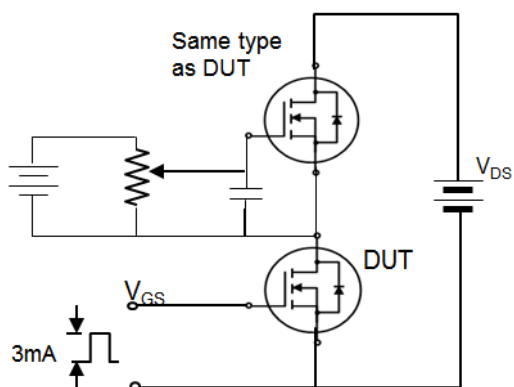
Avalanche Test Circuit



Switching Time Test Circuit



Gate Charge Test Circuit



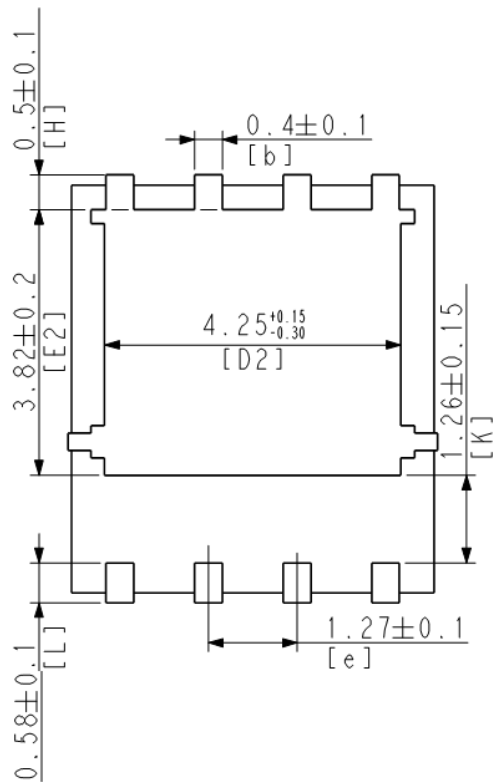
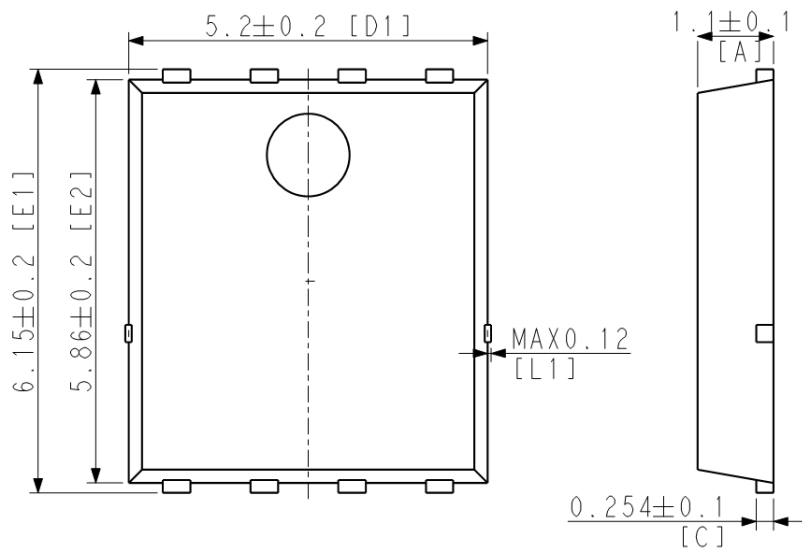
HY030N06C2

Device Per Unit

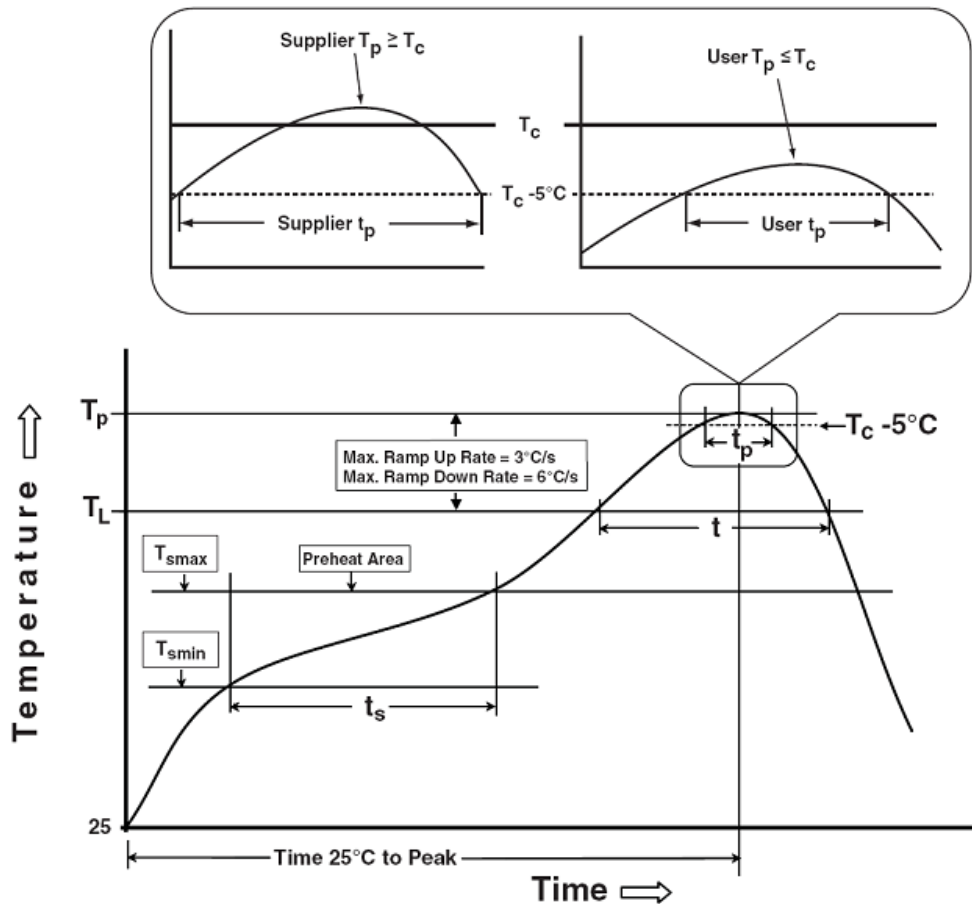
Package Type	Unit	Quantity
PPAK5*6-8L	Reel	5000

Package Information

PPAK5*6-8L



Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak		
Temperature min (T _{smin})	100 °C	150 °C
Temperature max (T _{smax})	150 °C	200 °C
Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds
Average ramp-up rate (T _{smax} to T _p)	3 °C/second max.	3°C/second max.
Liquidous temperature (T _L)	183 °C	217 °C
Time at liquidous (t _L)	60-150 seconds	60-150 seconds
Peak package body Temperature (T _p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t _p)** within 5°C of the specified classification temperature (T _c)	20** seconds	30** seconds
Average ramp-down rate (T _p to T _{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
*Tolerance for peak profile Temperature (T _p) is defined as a supplier minimum and a user maximum.		
** Tolerance for time at peak profile temperature (t _p) is defined as a supplier minimum and a user maximum.		

Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2.Pb-free Process – Classification Temperatures (Tc)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ ≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -55°C~150°C

Customer Service

Worldwide Sales and Service: sales@hymexa.com

Technical Support: Technology@hymexa.com

Xi'an Huayi Microelectronics Co., Ltd.

No.8928,Shangji Road,Economic and Technological Development Zone,Xi'an,China

TEL: (86-029) 86685706

FAX: (86-029) 86685705

E-mail: sales@hymexa.com

Web net: www.hymexa.com